Features

- Serial Peripheral Interface (SPI) Compatible
- Supports SPI Modes 0 (0,0) and 3 (1,1)
- Low-voltage and Standard-voltage Operation
 - $-2.7 (V_{CC} = 2.7V \text{ to } 5.5V)$
 - $-1.8 (V_{CC} = 1.8V \text{ to } 5.5V)$
- 20 MHz Clock Rate (5V)
- 32-byte Page Mode
- Block Write Protection
 - Protect 1/4, 1/2, or Entire Array
- Write Protect (WP) Pin and Write Disable Instructions for both Hardware and Software Data Protection
- Self-timed Write Cycle (5 ms Max)
- · High-reliability
 - Endurance: One Million Write Cycles
 - Data Retention: 100 Years
- Automotive Grade, Extended Temperature and Lead-free/Halogen-free Devices Available
- 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead MAP and 8-lead TSSOP Packages

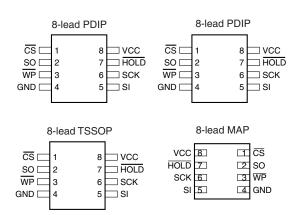
Description

The AT25080A/160A/320A/640A provides 8192/16384/32768/65536 bits of serial electrically-erasable programmable read only memory (EEPROM) organized as 1024/2048/4096/8192 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. The AT25080A/160A/320A/640A is available in space saving 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead MAP and 8-lead TSSOP packages.

The AT25080A/160A/320A/640A is enabled through the Chip Select pin (\overline{CS}) and accessed via a 3-wire interface consisting of Serial Data Input (SI), Serial Data Output (SO), and Serial Clock (SCK). All programming cycles are completely self-timed, and no separate ERASE cycle is required before WRITE.

Pin Configuration

Pin Name	Function
CS	Chip Select
SCK	Serial Data Clock
SI	Serial Data Input
SO	Serial Data Output
GND	Ground
VCC	Power Supply
WP	Write Protect
HOLD	Suspends Serial Input
NC	No Connect
DC	Don't Connect





SPI Serial EEPROMs 8K (1024 x 8) 16K (2048 x 8) 32K (4096 x 8) 64K (8192 x 8)

AT25080A AT25160A AT25320A AT25640A





BLOCK WRITE protection is enabled by programming the status register with one of four blocks of write protection. Separate program enable and program disable instructions are provided for additional data protection. Hardware data protection is provided via the $\overline{\text{WP}}$ pin to protect against inadvertent write attempts to the status register. The $\overline{\text{HOLD}}$ pin may be used to suspend any serial communication without resetting the serial sequence.

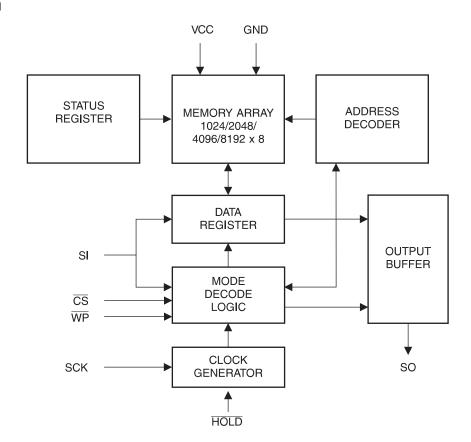
Absolute Maximum Ratings*

Operating Temperature	55°C to +125°C
Storage Temperature	65°C to +150°C
Voltage on Any Pin with Respect to Ground	1.0V to +7.0V
Maximum Operating Voltage	6.25V
DC Output Current	5.0 mA

*NOTICE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Block Diagram



Pin Capacitance⁽¹⁾

Applicable over recommended operating range from $T_A = 25^{\circ}C$, f = 1.0 MHz, $V_{CC} = +5.0V$ (unless otherwise noted).

Symbol	Test Conditions	Max	Units	Conditions
C _{OUT}	Output Capacitance (SO)	8	pF	V _{OUT} = 0V
C _{IN}	Input Capacitance(CS, SCK, SI, WP, HOLD)	6	pF	$V_{IN} = 0V$

Note: 1. This parameter is characterized and is not 100% tested.

DC Characteristics⁽¹⁾: T_{AI} = -40°C to +85°C

Applicable over recommended operating range from: $T_{Al} = -40^{\circ}C$ to $+85^{\circ}C$, $V_{CC} = +1.8V$ to +5.5V (unless otherwise noted).

Symbol	Parameter	Test Condition	Test Condition			Max	Units
V _{CC1}	Supply Voltage		1.8		5.5	V	
V _{CC2}	Supply Voltage			2.7		5.5	V
V _{CC3}	Supply Voltage		4.5		5.5	V	
I _{CC1}	Supply Current	V _{CC} = 5.0V at 20 MHz, S	5.0	7.5	10	mA	
I _{CC2}	Supply Current	V _{CC} = 5.0V at 10 MHz, S Read, Write	3.0	4.0	5.0	mA	
I _{SB1}	Standby Current	$V_{CC} = 1.8V, \overline{CS} = V_{CC}$		< 0.1	1.5	μΑ	
I _{SB2}	Standby Current	$V_{CC} = 2.7V, \overline{CS} = V_{CC}$		0.3	2.0	μΑ	
I _{SB3}	Standby Current	$V_{CC} = 5.0V, \overline{CS} = V_{CC}$			2.0	5.0	μΑ
I _{IL}	Input Leakage	$V_{IN} = 0V \text{ to } V_{CC}$		-3.0			μΑ
I _{OL}	Output Leakage	$V_{IN} = 0V \text{ to } V_{CC}, T_{AC} = 0^{\circ}$	C to 70°C	-3.0		3.0	μΑ
V _{IL} ⁽¹⁾	Input Low-voltage			-0.6		V _{CC} x 0.3	V
V _{IH} ⁽¹⁾	Input High-voltage			V _{CC} x 0.7		V _{CC} + 0.5	V
V _{OL1}	Output Low-voltage	4 EV - V E EV	I _{OL} = 3.0 mA			0.4	V
V _{OH1}	Output High-voltage	$4.5V \le V_{CC} \le 5.5V$	I _{OH} = -1.6 mA	V _{CC} - 0.8			V
V _{OL2}	Output Low-voltage	1.01/21/2.2.61/	I _{OL} = 0.15 mA			0.2	V
V _{OH2}	Output High-voltage	1.8V ≤ V _{CC} ≤ 3.6V	I _{OH} = -100 μA	V _{CC} - 0.2			V

Note: 1. V_{IL} min and V_{IH} max are reference only and are not tested.





DC Characteristics⁽¹⁾: T_{AE} = -40°C to +125°C

Applicable over recommended operating range from: $T_{AE} = -40^{\circ}C$ to $+125^{\circ}C$, $V_{CC} = +1.8V$ to +5.5V (unless otherwise noted).

Symbol	Parameter	Test Condition		Min	Тур	Max	Units
V _{CC1}	Supply Voltage		1.8		5.5	V	
V _{CC2}	Supply Voltage					5.5	٧
V _{CC3}	Supply Voltage			4.5		5.5	V
I _{CC1}	Supply Current	V _{CC} = 5.0V at 20 MHz, S	O = Open, Read	5.0	7.5	10	mA
I _{CC2}	Supply Current	V _{CC} = 5.0V at 10 MHz, S Read, Write	3.0	4.0	5.0	mA	
I _{SB1}	Standby Current	$V_{CC} = 1.8V, \overline{CS} = V_{CC}$		< 0.1	6	μΑ	
I _{SB2}	Standby Current	$V_{CC} = 2.7V, \overline{CS} = V_{CC}$		0.3	7	μΑ	
I _{SB3}	Standby Current	$V_{CC} = 5.0V, \overline{CS} = V_{CC}$			2.0	10	μΑ
I _{IL}	Input Leakage	$V_{IN} = 0V \text{ to } V_{CC}$		-3.0		3.0	μΑ
I _{OL}	Output Leakage	$V_{IN} = 0V \text{ to } V_{CC}, T_{AC} = 0^{\circ}$	C to 70°C	-3.0		3.0	μΑ
$V_{IL}^{(1)}$	Input Low-voltage			-0.6		V _{CC} x 0.3	V
V _{IH} ⁽¹⁾	Input High-voltage					V _{CC} + 0.5	V
V_{OL1}	Output Low-voltage	4 EV 2 V 2 E EV	I _{OL} = 3.0 mA			0.4	V
V _{OH1}	Output High-voltage	$4.5V \le V_{CC} \le 5.5V$	I _{OH} = -1.6 mA	V _{CC} - 0.8			V
V _{OL2}	Output Low-voltage	101/21/2001	I _{OL} = 0.15 mA			0.2	V
V _{OH2}	Output High-voltage	$1.8V \le V_{CC} \le 3.6V$	I _{OH} = -100 μA	V _{CC} - 0.2			V

Note: 1. V_{IL} min and V_{IH} max are reference only and are not tested.

AC Characteristics

Applicable over recommended operating range from T_{AI} = -40°C to +85°C, T_{AE} = -40°C to +125°C, V_{CC} = As Specified, CL = 1 TTL Gate and 30 pF (unless otherwise noted).

Symbol	Parameter	Voltage	Min	Max	Units
f _{sck}	SCK Clock Frequency	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	0 0 0	20 10 5	MHz
t _{RI}	Input Rise Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5		2 2 2	μs
t _{FI}	Input Fall Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5		2 2 2	μs
t _{wH}	SCK High Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	20 40 80		ns
t_{WL}	SCK Low Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	20 40 80		ns
t _{cs}	CS High Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	25 50 100		ns
t _{css}	CS Setup Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	25 50 100		ns
t _{CSH}	CS Hold Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	25 50 100		ns
t _{su}	Data In Setup Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	25 50 100		ns
t _H	Data In Hold Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	25 50 100		ns
t _{HD}	Hold Setup Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	25 50 100		
t _{CD}	Hold Hold Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	25 50 100		ns
t _v	Output Valid	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	0 0 0	20 40 80	ns
t _{HO}	Output Hold Time	4.5 - 5.5 2.7 - 5.5 1.8 - 5.5	0 0 0		ns





AC Characteristics (Continued)

Applicable over recommended operating range from T_{AI} = -40°C to +85°C, T_{AE} = -40°C to +125°C, V_{CC} = As Specified, CL = 1 TTL Gate and 30 pF (unless otherwise noted).

Symbol	Parameter	Voltage	Min	Max	Units
		4.5 - 5.5	0	25	
t_{LZ}	Hold to Output Low Z	2.7 - 5.5	0	50	ns
		1.8 - 5.5	0	100	
		4.5 - 5.5		25	
t_{HZ}	Hold to Output High Z	2.7 - 5.5		50	ns
	1.8 - 5.5		100		
		4.5 - 5.5		25	
t_{DIS}	Output Disable Time	2.7 - 5.5		50	ns
2.0		1.8 - 5.5		100	
		4.5 - 5.5		5	
t _{WC}	Write Cycle Time	2.7 - 5.5		5	ms
		1.8 - 5.5		5	
Endurance ⁽¹⁾	5.0V, 25°C, Page Mode		1M		Write Cycles

Note: 1. This parameter is characterized and is not 100% tested.

Serial Interface Description

MASTER: The device that generates the serial clock.

SLAVE: Because the Serial Clock pin (SCK) is always an input, the AT25080A/160A/320A/640A always operates as a slave.

TRANSMITTER/RECEIVER: The AT25080A/160A/320A/640A has separate pins designated for data transmission (SO) and reception (SI).

MSB: The Most Significant Bit (MSB) is the first bit transmitted and received.

SERIAL OP-CODE: After the device is selected with \overline{CS} going low, the first byte will be received. This byte contains the op-code that defines the operations to be performed.

INVALID OP-CODE: If an invalid op-code is received, no data will be shifted into the AT25080A/160A/320A/640A, and the serial output pin (SO) will remain in a high impedance state until the falling edge of $\overline{\text{CS}}$ is detected again. This will reinitialize the serial communication.

CHIP SELECT: The AT25080A/160A/320A/640A is selected when the $\overline{\text{CS}}$ pin is low. When the device is not selected, data will not be accepted via the SI pin, and the serial output pin (SO) will remain in a high impedance state.

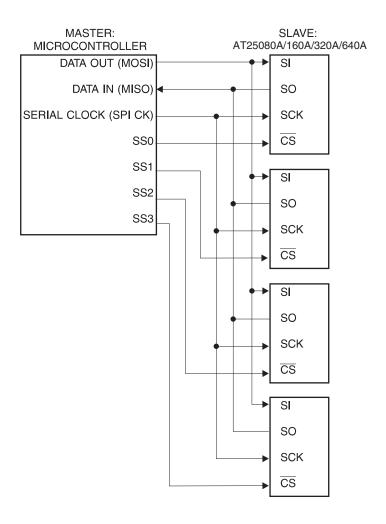
HOLD: The $\overline{\text{HOLD}}$ pin is used in conjunction with the $\overline{\text{CS}}$ pin to select the AT25080A/160A/320A/640A. When the device is selected and a serial sequence is underway, $\overline{\text{HOLD}}$ can be used to pause the serial communication with the master device without resetting the serial sequence. To pause, the $\overline{\text{HOLD}}$ pin must be brought low while the SCK pin is low. To resume serial communication, the $\overline{\text{HOLD}}$ pin is brought high while the SCK pin is low (SCK may still toggle during $\overline{\text{HOLD}}$). Inputs to the SI pin will be ignored while the SO pin is in the high impedance state.

WRITE PROTECT: The write protect pin (\overline{WP}) will allow normal read/write operations when held high. When the WP pin is brought low and WPEN bit is "1", all write operations to the status register are inhibited. \overline{WP} going low while \overline{CS} is still low will interrupt a write to the status register. If the internal write cycle has already been initiated, \overline{WP} going low will have no effect on any write operation to the status register. The \overline{WP} pin function is blocked when the WPEN bit in the status register is "0". This will allow the user to install the AT25080A/160A/320A/640A in a system with the \overline{WP} pin tied to ground and still be able to write to the status register. All \overline{WP} pin functions are enabled when the WPEN bit is set to "1".





SPI Serial Interface



Functional Description

The AT25080A/160A/320A/640A is designed to interface directly with the synchronous serial peripheral interface (SPI) of the 6805 and 68HC11 series of microcontrollers.

The AT25080A/160A/320A/640A utilizes an 8-bit instruction register. The list of instructions and their operation codes are contained in Table 1. All instructions, addresses, and data are transferred with the MSB first and start with a high-to-low CS transition.

Table 1. Instruction Set for the AT25080A/160A/320A/640A

Instruction Name	Instruction Format	Operation
WREN	0000 X110	Set Write Enable Latch
WRDI	0000 X100	Reset Write Enable Latch
RDSR	0000 X101	Read Status Register
WRSR	0000 X001	Write Status Register
READ	0000 X011	Read Data from Memory Array
WRITE	0000 X010	Write Data to Memory Array

WRITE ENABLE (WREN): The device will power-up in the write disable state when V_{CC} is applied. All programming instructions must therefore be preceded by a Write Enable instruction.

WRITE DISABLE (WRDI): To protect the device against inadvertent writes, the Write Disable instruction disables all programming modes. The WRDI instruction is independent of the status of the $\overline{\text{WP}}$ pin.

READ STATUS REGISTER (RDSR): The Read Status Register instruction provides access to the status register. The READY/BUSY and Write Enable status of the device can be determined by the RDSR instruction. Similarly, the Block Write Protection bits indicate the extent of protection employed. These bits are set by using the WRSR instruction.

Table 2. Status Register Format

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
WPEN	Х	Х	Х	BP1	BP0	WEN	RDY

Table 3. Read Status Register Bit Definition

Bit	Definition				
Bit 0 (RDY)	Bit $0 = 0$ (\overline{RDY}) indicates the device is READY. Bit $0 = 1$ indicates the write cycle is in progress.				
Bit 1 (WEN)	Bit 1= 0 indicates the device is not WRITE ENABLED. Bit 1 = 1 indicates the device is WRITE ENABLED.				
Bit 2 (BP0)	See Table 4 on page 10.				
Bit 3 (BP1)	See Table 4 on page 10.				
Bits 4 - 6 are 0s w	hen device is not in an internal write cycle.				
Bit 7 (WPEN)	See Table 5 on page 10.				
Bits 0 - 7 are 1s do	Bits 0 - 7 are 1s during an internal write cycle.				





WRITE STATUS REGISTER (WRSR): The WRSR instruction allows the user to select one of four levels of protection. The AT25080A/160A/320A/640A is divided into four array segments. One quarter (1/4), one half (1/2), or all of the memory segments can be protected. Any of the data within any selected segment will therefore be READ only. The block write protection levels and corresponding status register control bits are shown in Table 4.

The three bits, BP0, BP1, and WPEN are nonvolatile cells that have the same properties and functions as the regular memory cells (e.g. WREN, t_{WC} , RDSR).

Table 4. Block Write Protect Bits

	Status Register Bits		Array Addresses Protected				
Level	BP1	BP0	AT25080A AT25160A AT25320A AT25				
0	0	0	None	None	None	None	
1(1/4)	0	1	0300 -03FF	0600 -07FF	0C00 -0FFF	1800 -1FFF	
2(1/2)	1	0	0200 -03FF	0400 -07FF	0800 -0FFF	1000 -1FFF	
3(All)	1	1	0000 -03FF	0000 -07FF	0000 -0FFF	0000 -1FFF	

The WRSR instruction also allows the user to enable or disable the write protect (\overline{WP}) pin through the use of the Write Protect Enable (WPEN) bit. Hardware write protection is enabled when the \overline{WP} pin is low and the WPEN bit is "1". Hardware write protection is disabled when either the \overline{WP} pin is high or the WPEN bit is "0". When the device is hardware write protected, writes to the Status Register, including the Block Protect bits and the WPEN bit, and the block-protected sections in the memory array are disabled. Writes are only allowed to sections of the memory which are not block-protected.

NOTE: When the WPEN bit is hardware write protected, it cannot be changed back to "0", as long as the \overline{WP} pin is held low.

Table 5. WPEN Operation

WPEN	WP	WEN	Protected Blocks	Unprotected Blocks	Status Register
0	Х	0	Protected	Protected	Protected
0	Х	1	Protected	Writable	Writable
1	Low	0	Protected	Protected	Protected
1	Low	1	Protected	Writable	Protected
Х	High	0	Protected	Protected	Protected
Х	High	1	Protected	Writable	Writable

READ SEQUENCE (READ): Reading the AT25080A/160A/320A/640A via the SO (Serial Output) pin requires the following sequence. After the \overline{CS} line is pulled low to select a device, the READ op-code is transmitted via the SI line followed by the byte address to be read (A15 - A0, Refer to Table 6). Upon completion, any data on the SI line will be ignored. The data (D7 - D0) at the specified address is then shifted out onto the SO line. If only one byte is to be read, the \overline{CS} line should be driven high after the data comes out. The READ sequence can be continued since the byte address is automatically incremented and data will continue to be shifted out. When the highest address is reached, the address counter will roll over to the lowest address allowing the entire memory to be read in one continuous READ cycle.

WRITE SEQUENCE (WRITE): In order to program the AT25080A/160A/320A/640A, two separate instructions must be executed. First, the device **must be write enabled** via the Write Enable (WREN) Instruction. Then a Write (WRITE) Instruction may be executed. Also, the address of the memory location(s) to be programmed must be outside the protected address field location selected by the Block Write Protection Level. During an internal write cycle, all commands will be ignored except the RDSR instruction.

A Write Instruction requires the following sequence. After the $\overline{\text{CS}}$ line is pulled low to select the device, the WRITE op-code is transmitted via the SI line followed by the byte address (A15 - A0) and the data (D7 - D0) to be programmed (Refer to Table 6). Programming will start after the $\overline{\text{CS}}$ pin is brought high. (The LOW-to-High transition of the $\overline{\text{CS}}$ pin must occur during the SCK low-time immediately after clocking in the D0 (LSB) data bit.

The READY/BUSY status of the device can be determined by initiating a READ STATUS REGISTER (RDSR) Instruction. If Bit 0 = 1, the WRITE cycle is still in progress. If Bit 0 = 0, the WRITE cycle has ended. Only the READ STATUS REGISTER instruction is enabled during the WRITE programming cycle.

The AT25080A/160A/320A/640A is capable of a 32-byte PAGE WRITE operation. After each byte of data is received, the five low order address bits are internally incremented by one; the high order bits of the address will remain constant. If more than 32 bytes of data are transmitted, the address counter will roll over and the previously written data will be overwritten. The AT25080A/160A/320A/640A is automatically returned to the write disable state at the completion of a WRITE cycle.

NOTE: If the device is not Write enabled (WREN), the device will ignore the Write instruction and will return to the standby state, when \overline{CS} is brought high. A new \overline{CS} falling edge is required to re-initiate the serial communication.

Table 6. Address Key

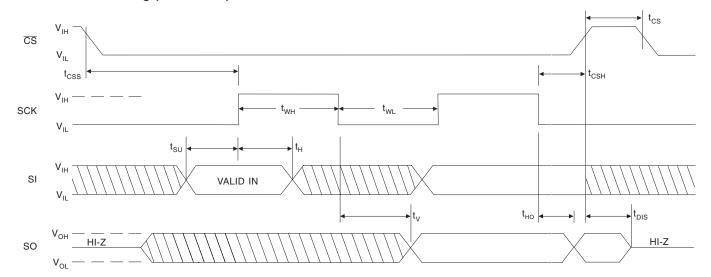
Address	AT25080A	AT25160A	AT25320A	AT25640A
A _N	A ₉ - A ₀	A ₁₀ - A ₀	A ₁₁ - A ₀	A ₁₂ - A ₀
Don't Care Bits	A ₁₅ - A ₁₀	A ₁₅ - A ₁₁	A ₁₅ - A ₁₂	A ₁₅ - A ₁₃



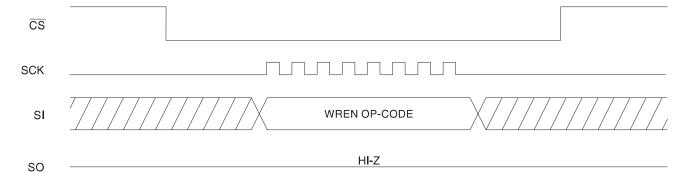


Timing Diagrams

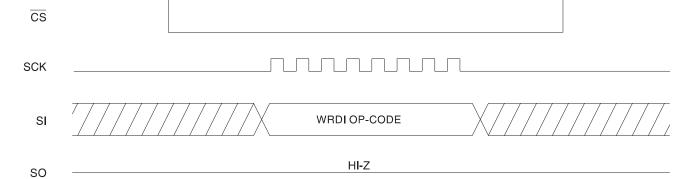
Synchronous Data Timing (for Mode 0)



WREN Timing



WRDI Timing



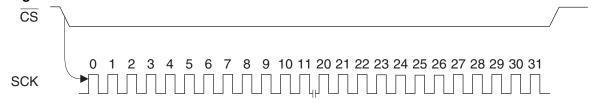
RDSR Timing CS 10 11 12 13 14 SCK **INSTRUCTION** SI **DATA OUT** HIGH IMPEDANCE SO 4 **MSB WRSR Timing** CS SCK DATA IN SI **INSTRUCTION** HIGH IMPEDANCE SO **READ Timing** CS 6 7 8 9 10 11 20 21 22 23 24 25 26 27 28 29 30 31 SCK **BYTE ADDRESS** SI **INSTRUCTION DATA OUT** HIGH IMPEDANCE SO



MSB



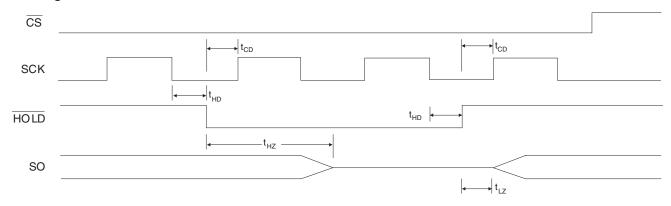
WRITE Timing





SO HIGH IMPEDANCE

HOLD Timing



AT25080A Ordering Information

Ordering Code	Package	Operation Range
AT25080A-10PI-2.7	8P3	
AT25080AN-10SI-2.7	8S1	Industrial Temperature
AT25080A-10TI-2.7	8A2	(–40 to 85°C)
AT25080AY1-10YI-2.7	8Y1	
AT25080A-10PI-1.8	8P3	
AT25080AN-10SI-1.8	8S1	Industrial Temperature
AT25080A-10TI-1.8	8A2	(-40 to 85°C)
AT25080AY1-10YI-1.8	8Y1	
AT25080AN-10SU-2.7	8S1	Load froe/Hologon froe/
AT25080AN-10SU-1.8	8S1	Lead-free/Halogen-free/
AT25080A-10TU-2.7	8A2	Industrial Temperature
AT25080A-10TU-1.8	8A2	(–40 to 85°C)
AT25080AN-10SE-2.7	8S1	High Grade/Extended Temperature
A123000AN-103E-2.7	551	(-40 to 125°C)

	Package Type			
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)			
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)			
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)			
	Options			
-2.7	Low Voltage (2.7 to 5.5V)			
-1.8	Low Voltage (1.8 to 5.5V)			





AT25160A Ordering Information

Ordering Code	Package	Operation Range
AT25160A-10PI-2.7	8P3	
AT25160AN-10SI-2.7	8S1	Industrial Temperature
AT25160A-10TI-2.7	8A2	(-40 to 85°C)
AT25160AY1-10YI-2.7	8Y1	
AT25160A-10PI-1.8	8P3	
AT25160AN-10SI-1.8	8S1	Industrial Temperature
AT25160A-10TI-1.8	8A2	(-40 to 85°C)
AT25160AY1-10YI-1.8	8Y1	
AT25160AN-10SU-2.7	8S1	Load from Albahaman from A
AT25160AN-10SU-1.8	8S1	Lead-free/Halogen-free/
AT25160A-10TU-2.7	8A2	Industrial Temperature
AT25160A-10TU-1.8	8A2	(–40 to 85°C)
ATOM (COAN 100F 0.7	001	High Grade/Extended Temperature
AT25160AN-10SE-2.7	8S1	(–40 to 125°C)

	Package Type			
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)			
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)			
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)			
	Options			
-2.7	Low Voltage (2.7 to 5.5V)			
-1.8	Low Voltage (1.8 to 5.5V)			

AT25320A Ordering Information

Ordering Code	Package	Operation Range
AT25320A-10PI-2.7	8P3	
AT25320AN-10SI-2.7	8S1	Industrial Temperature
AT25320A-10TI-2.7	8A2	(–40 to 85°C)
AT25320AY1-10YI-2.7	8Y1	
AT25320A-10PI-1.8	8P3	
AT25320AN-10SI-1.8	8S1	Industrial Temperature
AT25320A-10TI-1.8	8A2	(–40 to 85°C)
AT25320AY1-10YI-1.8	8Y1	
AT25320AN-10SU-2.7	8S1	Lead-free/Halogen-free/
AT25320AN-10SU-1.8	8S1	
AT25320A-10TU-2.7	8A2	Industrial Temperature
AT25320A-10TU-1.8	8A2	(–40 to 85°C)
AT05200AN 10SE 2.7	8S1	High Grade/Extended Temperature
AT25320AN-10SE-2.7	631	(-40 to 125°C)

Package Type				
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)			
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)			
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)			
	Options			
-2.7	Low Voltage (2.7 to 5.5V)			
-1.8	Low Voltage (1.8 to 5.5V)			





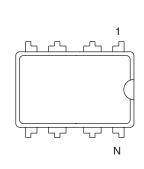
AT25640A Ordering Information

Ordering Code	Package	Operation Range
AT25640A-10PI-2.7	8P3	
AT25640AN-10SI-2.7	8S1	Industrial Temperature
AT25640A-10TI-2.7	8A2	(-40 to 85°C)
AT25640AY1-10YI-2.7	8Y1	
AT25640A-10PI-1.8	8P3	
AT25640AN-10SI-1.8	8S1	Industrial Temperature
AT25640A-10TI-1.8	8A2	(−40 to 85°C)
AT25640AY1-10YI-1.8	8Y1	
AT25640AN-10SU-2.7	8S1	Lood from / Lologon from /
AT25640AN-10SU-1.8	8S1	Lead-free/Halogen-free/
AT25640A-10TU-2.7	8A2	Industrial Temperature
AT25640A-10TU-1.8	8A2	(-40 to 85°C)
		High Grade/Extended Temperature
AT25640AN-10SE-2.7	8S1	(-40 to 125°C)
AT25640AN-10SQ-2.7	8S1	Lead-free/Halogen-free/ High Grade/Extended Temperature (–40 to 125°C)

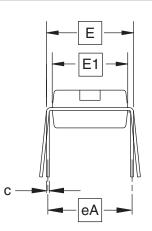
Package Type				
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)			
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)			
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)			
	Options			
-2.7	Low Voltage (2.7 to 5.5V)			
-1.8	Low Voltage (1.8 to 5.5V)			

Packaging Information

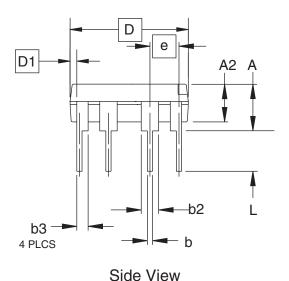
8P3 - PDIP



Top View



End View



COMMON DIMENSIONS

(Unit of Measure = inches)

SYMBOL	MIN	NOM	MAX	NOTE
Α			0.210	2
A2	0.115	0.130	0.195	
b	0.014	0.018	0.022	5
b2	0.045	0.060	0.070	6
b3	0.030	0.039	0.045	6
С	0.008	0.010	0.014	
D	0.355	0.365	0.400	3
D1	0.005			3
E	0.300	0.310	0.325	4
E1	0.240	0.250	0.280	3
е	0.100 BSC			
eA	0.300 BSC			4
L	0.115	0.130	0.150	2

Notes:

- 1. This drawing is for general information only; refer to JEDEC Drawing MS-001, Variation BA for additional information.
- 2. Dimensions A and L are measured with the package seated in JEDEC seating plane Gauge GS-3.
- 3. D, D1 and E1 dimensions do not include mold Flash or protrusions. Mold Flash or protrusions shall not exceed 0.010 inch.
- 4. E and eA measured with the leads constrained to be perpendicular to datum.
- 5. Pointed or rounded lead tips are preferred to ease insertion.
- 6. b2 and b3 maximum dimensions do not include Dambar protrusions. Dambar protrusions shall not exceed 0.010 (0.25 mm).

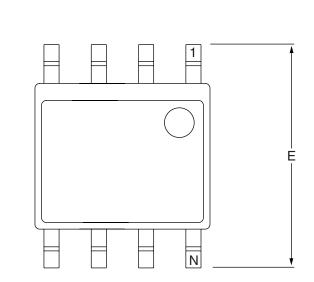
01/09/02



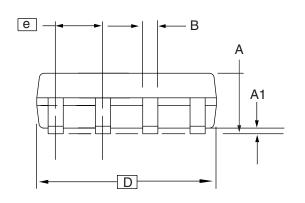




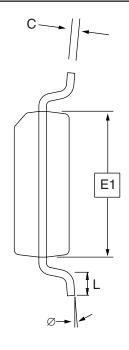
8S1 – JEDEC SOIC



Top View



Side View



End View

COMMON DIMENSIONS

(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
Α	1.35	_	1.75	
A1	0.10	-	0.25	
b	0.31	_	0.51	
С	0.17	_	0.25	
D	4.80	-	5.00	
E1	3.81	_	3.99	
E	5.79	-	6.20	
е		1.27 BSC		
L	0.40	_	1.27	
Ø	0°	_	8°	

Note: These drawings are for general information only. Refer to JEDEC Drawing MS-012, Variation AA for proper dimensions, tolerances, datums, etc.

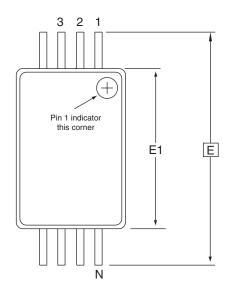
10/7/03



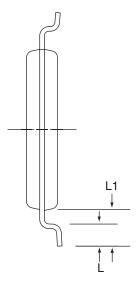
1150 E. Cheyenne Mtn. Blvd. Colorado Springs, CO 80906 **TITLE 8S1**, 8-lead (0.150" Wide Body), Plastic Gull Wing Small Outline (JEDEC SOIC)

BS1 REV.

8A2 - TSSOP



Top View



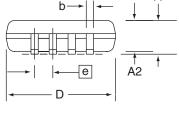
End View

COMMON DIMENSIONS

(Unit of Measure = mm)



SYMBOL	MIN	NOM	MAX	NOTE
D	2.90	3.00	3.10	2, 5
Е		6.40 BSC		
E1	4.30	4.40	4.50	3, 5
Α	_	_	1.20	
A2	0.80	1.00	1.05	
b	0.19	_	0.30	4
е	0.65 BSC			
L	0.45	0.60	0.75	
L1	1.00 REF			



Side View

Notes: 1. This drawing is for general information only. Refer to JEDEC Drawing MO-153, Variation AA, for proper dimensions, tolerances, datums, etc.

- 2. Dimension D does not include mold Flash, protrusions or gate burrs. Mold Flash, protrusions and gate burrs shall not exceed 0.15 mm (0.006 in) per side.
- 3. Dimension E1 does not include inter-lead Flash or protrusions. Inter-lead Flash and protrusions shall not exceed 0.25 mm (0.010 in) per side.
- 4. Dimension b does not include Dambar protrusion. Allowable Dambar protrusion shall be 0.08 mm total in excess of the b dimension at maximum material condition. Dambar cannot be located on the lower radius of the foot. Minimum space between protrusion and adjacent lead is 0.07 mm.
- 5. Dimension D and E1 to be determined at Datum Plane H.

5/30/02



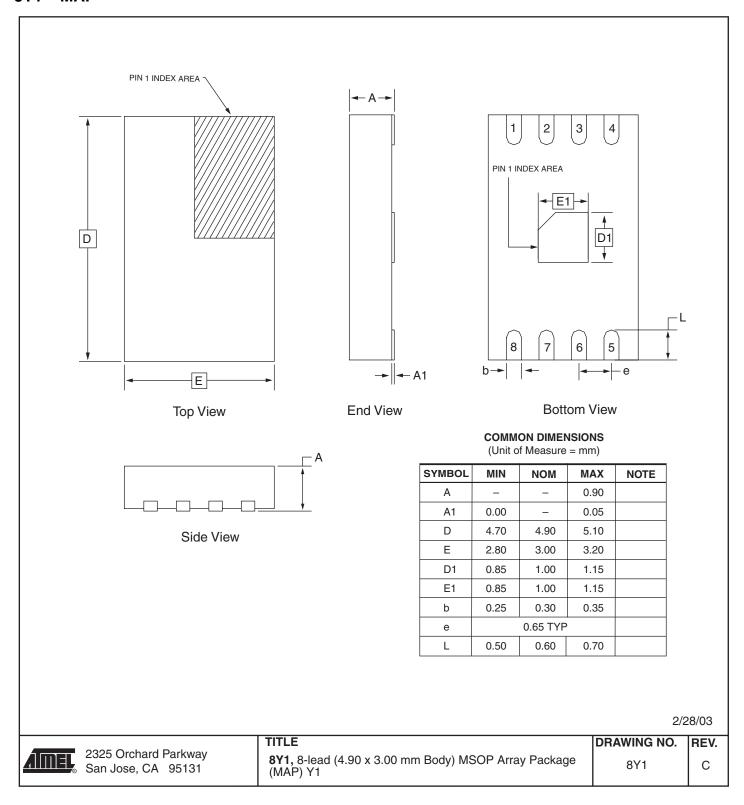
2325 Orchard Parkway San Jose, CA 95131 **TITLE 8A2**, 8-lead, 4.4 mm Body, Plastic
Thin Shrink Small Outline Package (TSSOP)

DRAWING NO. REV. 8A2 B





8Y1 - MAP





Atmel Corporation

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311

Fax: 1(408) 487-2600

Regional Headquarters

Europe

Atmel Sarl Route des Arsenaux 41 Case Postale 80 CH-1705 Fribourg Switzerland

Tel: (41) 26-426-5555 Fax: (41) 26-426-5500

Asia

Room 1219 Chinachem Golden Plaza 77 Mody Road Tsimshatsui East Kowloon Hong Kong

Tel: (852) 2721-9778 Fax: (852) 2722-1369

Japan

9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 Japan

Tel: (81) 3-3523-3551 Fax: (81) 3-3523-7581

Atmel Operations

Memory

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

Microcontrollers

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

La Chantrerie BP 70602 44306 Nantes Cedex 3, France Tel: (33) 2-40-18-18-18 Fax: (33) 2-40-18-19-60

ASIC/ASSP/Smart Cards

Zone Industrielle 13106 Rousset Cedex, France Tel: (33) 4-42-53-60-00

Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA

Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

Scottish Enterprise Technology Park Maxwell Building East Kilbride G75 0QR, Scotland

Tel: (44) 1355-803-000 Fax: (44) 1355-242-743

RF/Automotive

Theresienstrasse 2 Postfach 3535 74025 Heilbronn, Germany Tel: (49) 71-31-67-0

Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA

Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

Biometrics/Imaging/Hi-Rel MPU/ High Speed Converters/RF Datacom

Avenue de Rochepleine

BP 123

38521 Saint-Egreve Cedex, France

Tel: (33) 4-76-58-30-00 Fax: (33) 4-76-58-34-80

Literature Requests www.atmel.com/literature

Disclaimer: Atmel Corporation makes no warranty for the use of its products, other than those expressly contained in the Company's standard warranty which is detailed in Atmel's Terms and Conditions located on the Company's web site. The Company assumes no responsibility for any errors which may appear in this document, reserves the right to change devices or specifications detailed herein at any time without notice, and does not make any commitment to update the information contained herein. No licenses to patents or other intellectual property of Atmel are granted by the Company in connection with the sale of Atmel products, expressly or by implication. Atmel's products are not authorized for use as critical components in life support devices or systems.

© Atmel Corporation 2004. All rights reserved. Atmel® and combinations thereof, are the registered trademarks of Atmel Corporation or its subsidiaries. Other terms and product names may be the trademarks of others.

